

SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

CUSTOMER:

DATE :

(客戶):

(日期):2020-08-26

CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: RH 450V6.8μF(φ10X12.5)
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

SUPPLI	ER	CU	STOMER
PREPARED (拟定)	CHECKED (审核)	APPROVAL (批准)	SIGNATURE (签名)
邓文文	付婷婷		

ELECTROLYTIC CAPACITOR SPECIFICATION RH SERIES

		SPECIFIC RH SE				ALTERN	ATION HIS RECORDS	STORY
Rev.	Date	Mark		age	Contents	Purpose	Drafter	Approver
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	.		0.1					
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	MAN YUE ELECTRO COMPANY LIMIT				ELECTR CAPAC SPECIFI RH SE	CITOR CATION				SAM	(0)	J	
Tab	le 1 Product Dimens Safety vent for $\geq \Phi 6.3$ L+ α max	ions an +] - 15 m		acteristics	 ↓ ↓	F:	±0.5	α β * If it is flat ru surface.	ΦD<20	20:α=1.5; L2 0:β=0.5; ΦI re is no bulg	5≥20:	β =1.0	Unit:mm
Table	91:												
N o.	SAMXON Part No.	WV (Vdc)	Cap. (µF)	Cap tolerance	Temp. range(°C)	tan δ (120Hz, 20°C)	Leakage Current (µA,2min)	Max Ripple Current at 105°C 100kHz (mA rms)	Load lifetime (Hrs)		ension mm) F	фd	Sleeve
1	ERH685M2WG1BRR**Q-R	450	6.8	-20%~+20%	-25~105	0.20	86	122	10000	10X12.5	5.0	0.6	PET
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 Part Number System Part Number System Construction Construction Characteristics Characteristics Characteristics Capacitance (Tolerance) Leakage current Leakage current Leakage current Leakage current Leakage current Terminal strength Te	 Part Number System Construction Construction Characteristics Characteristics Characteristics Capacitance (Tolerance) Leakage current Leakage current Leakage current Leakage current Terminal strength Terminal strength Temperature characteristic Load life test Shelf life test Surge test Vibration Solderability test Resistance to solder heat Scharge of temperature Lage of temperature Maximum permissible (ripple current) List of "Environment-related Substances to be Controlled ('Controlled 	C O N T E N T S	Sheet
 S. Construction 5 Characteristics 5~10 Rated voltage & Surge voltage Capacitance (Tolerance) Leakage current Leakage current tanδ Terminal strength Terminal strength Temperature characteristic Todal life test Shelf life test She	 3. Construction 5 4. Characteristics 5~10 4.1 Rated voltage & Surge voltage 4.2 Capacitance (Tolerance) 4.3 Leakage current 4.4 tanõ 4.5 Terminal strength 4.6 Temperature characteristic 4.7 Load life test 4.8 Shelf life test 4.9 Surge test 4.10 Vibration 4.11 Solderability test 4.12 Resistance to solder heat 4.13 Change of temperature 4.14 Damp heat test 4.15 Vent test 4.16 Maximum permissible (ripple current) 5. List of "Environment-related Substances to be Controlled ('Controlled Substances')" 	Application	4
 5-10 A. Characteristics 5-10 A.1 Rated voltage & Surge voltage 4.2 Capacitance (Tolerance) 4.3 Leakage current 4.4 tanõ 4.5 Terminal strength 4.6 Temperature characteristic 4.7 Load life test 4.8 Shelf life test 4.9 Surge test 4.10 Vibration 4.11 Solderability test 4.12 Resistance to solder heat 4.13 Change of temperature 4.14 Damp heat test 4.15 Vent test 4.16 Maximum permissible (ripple current) 5. List of "Environment-related Substances to be Controlled ('Controlled Substances')" 	 4. Characteristics 5~10 4.1 Rated voltage & Surge voltage 4.2 Capacitance (Tolerance) 4.3 Leakage current 4.4 tanõ 4.5 Terminal strength 4.6 Temperature characteristic 4.7 Load life test 4.8 Shelf life test 4.9 Surge test 4.10 Vibration 4.11 Solderability test 4.12 Resistance to solder heat 4.13 Change of temperature 4.14 Damp heat test 4.15 Vent test 4.16 Maximum permissible (ripple current) 5. List of "Environment-related Substances to be Controlled ('Controlled Substances')" 	Part Number System	4
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Substances')"	Substances')"	16 Maximum permissible (ripple current)	
Attachment: Application Guidelines 12~15	Attachment: Application Guidelines 12~15		11
		Attachment: Application Guidelines	12~15

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ELECTROLYTIC CAPACITOR SPECIFICATION RH SERIES



1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

2. Part Number System 123 456 7 89 101112 1314 1516 17 Ρ EGS 1 0 5 м 1 H D 1 1 TC S SAMXON SLEEVE PRODUCT LINE MATERIAL VOLTAGE SERIES CAPACITANCE CASE SIZE TOI TYPE Feature Code Cap(MFD) Code Tolerance (%) Code Voltage (W.V.) Code Case Size SAMXON Product Lin ries ESM EKF ESS EKS 0D 3 B 3.5 1 4 C 5 D 6.3 E For internal use only RR Radial bulk 0.1 104 ±5 J 2.5 0E (The product lines 0G 4 we have H.A.B.C.D. Ammo Taping 0.22 224 EGS 6.3 OJ 8 F 10 G 3 EGS EKM EKG EOM EZS EGF ESF ±10 к E,M or 0,1,2,3,4,5,9) 8 0K 2.0mm Pitch тт 0.33 334 10 1A L 2. 13 13.5 14 4.5 c 12 ±15 12.5 1B J V τυ 2.5mm Pitch 0.47 474 16 1C м EGF EGK EGE EGD EGC +20 20 1D 3.5mm Pitch тν 105 Sleeve Material Code 1 16.5 16.5 25 1E Р PET 5.0mm Pitch тс 30 11 2.2 225 Ν ±30 18.5 32 13 ERS ERF ERL ERR 35 1V Lead Cut & Form 3.3 335 -40 w ⋚ If the 40 1G 25 30 34 35 40 СВ-Туре СВ 42 1M 4.7 475 Sleeve I -20 0 ERT ERE ERD ERH EBD А 50 1H СЕ-Туре CE 10 106 57 1L material is PVC, -20 +10 63 **1**J С <u>42</u> 45 HE HE-Type 22 226 71 15 40 51 63.5 76 80 90 100 ERA ERB ERC EFA -20 +40 75 1**T** x KD-Type KD 33 336 80 1K 85 1R -20 +50 FD-Type FD s there will be blank in seventeenth 476 ENH ERW ERY ELP EAP 47 90 19 Caste 45 054 07 77 72 12 14 12 18 13 120 25 2J 30 35 3E 100 2A 4.5 -10 EH-Type EH в 100 107 120 20 5.4 125 2B PCB Termial $\begin{array}{r} 7\\ \hline 7.7\\ \hline 10.2\\ \hline 11\\ \hline 11.5\\ \hline 12\\ \hline 2.5\\ \hline 13\\ \hline \\ 13\\ \hline \end{array}$ -10 +20 227 220 EQP EDP v 150 2Z 160 2C sw ETP EHP EUP 337 330 -10 +30 180 2P Q 2D 200 Snap-in sx EKP EEP EFP ESP EVP 470 477 -10 +50 215 22 т 220 2N 13.5 sz 2200 228 -5 +10 digit 230 23 20 25 29.5 Е 250 2E Lug SG EGP EWR EWU EWT EWS EWF EWS EWH EWL EWB 22000 229 275 2Т 30 31.5 35 35.5 -5 +15 F 300 21 05 35.5 50 80 100 105 110 120 30 40 33000 339 310 2R -5 +20 G 50 80 1L 1M 1N 1P 06 2F 315 47000 479 2U 330 0 +20 R 350 Т5 2V 10T 100000 Screw 2X 0 +30 360 0 т6 VNS VKS VKM VRL VNH 375 2Q 150000 15T 10 10 1R 1E 2Y 40 50 55 385 +50 Т D5 400 2G 220000 22T 15 1F 1T +5 +15 z 420 2M D6 VZS 450 2W 330000 33T +5 D 500 2H 550 25 1000000 10M +10+50 Y 600 26 630 2J 1500000 15M +10 +30 н 2200000 22M 3300000 33M 5

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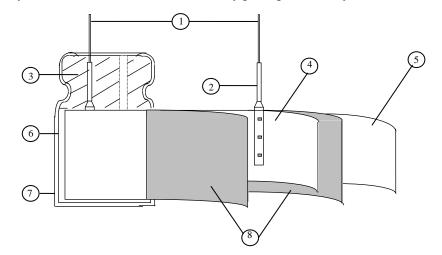
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ELECTROLYTIC CAPACITOR SPECIFICATION RH SERIES

SAMXON

3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



No	Component	Material		
1	Lead line	Tinned CP wire (Pb Free)		
2	Terminal	Aluminum wire		
3	Sealing Material	Rubber		
4	Al-Foil (+)	Formed aluminum foil		
5	Al-Foil (-)	Etched aluminum foil or formed aluminum foil		
6	Case	Aluminum case		
7	Sleeve	PET		
8	Separator	Electrolyte paper		

4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:

Ambient temperature	$: 20^{\circ}C \pm 2^{\circ}C$
Relative humidity	: 60% to 70%
Air Pressure	: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2.

Varian	01		5
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Tuon	e 2		DEDEODIANCE	
	ITEM		PERFORMANCE	
4.1	Rated voltage (WV)	WV (V.DC) 450		
	Surge voltage (SV)	SV (V.DC) 500		
	Nominal	e 1 5	0Hz±12Hz t more than 0.5Vrms	
4.2	capacitance (Tolerance)	Measuring Temperature : 20	±2℃	
		< Criteria > Shall be within the specified ca	pacitance tolerance.	
	Leakage	<condition> Connecting the capacitor with minutes, and then, measure Lea</condition>	-	$(1k\Omega \pm 10\Omega)$ in series for
4.3	current	<criteria> Refer to Table 1</criteria>		
		<condition></condition> See 4.2, Norm Capacitance, for	measuring frequency	v, voltage and temperature.
4.4	tanδ	< Criteria> Refer to Table 1		
		<condition> Tensile Strength of Terminals Fixed the capacitor, applied seconds. Bending Strength of Terminal Fixed the capacitor, applied for 90° within 2~3 seconds, and t seconds.</condition>	force to the terminal s. orce to bent the termin	
4.5	Terminal	Diameter of lead wire	Tensile force N (kgf)	Bending force N (kgf)
+ .J	strength	0.5mm and less	5 (0.51)	2.5 (0.25)
		Over 0.5mm to 0.8mm	10 (1.0)	5 (0.51)
		< Criteria> No noticeable changes sha	ll be found, no breaka	age or looseness at the termina

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		<condition></condition>			
		STEI	0 1		
		1	20±2	1	
		2	-25 ±	1	
		3	20±2	1	
		4	105±	1	
	Temperature	5	20±2	Time to reach thermal equilibriu	m
	characteristi	<criter< td=""><td>ia></td><td></td><td></td></criter<>	ia>		
4.6	cs		shall be within the l	imit of Item 4.4	
				ured shall not more than 8 times of its specified	d value.
			-	ithin the limit of Item 4.4	
		The le	eakage current shall	not more than the specified value.	
			-	atio shall not exceed the value of the following	g table.
			0 0 0	-50	
			25°C/Z+20°C	6	
		Capacitance,	$tan\delta$, and impedar	ce shall be measured at 120Hz.	
		<condition></condition>	1 IEC(0204		
			•	4No.4.13 methods, The capacitor is stored at a ± 2 with DC bias voltage plus the rated ripple	
			-	$D \simeq 2$ with DC bias voltage plus the rated hppic DC and ripple peak voltage shall not exceed t	
				e product should be tested after 16 hours red	
			t atmospheric condi		2010-102
	x 1	The re	esult should meet th		
4.7	Load life	<crite< td=""><td></td><td></td><td></td></crite<>			
4.7	test			et the following requirements. Value in 4.3 shall be satisfied	
			age current		
			citance Change	Within $\pm 20\%$ of initial value.	
		tanδ		Not more than 200% of the specified value.	
		Appe	arance	There shall be no leakage of electrolyte.	
		<condition< td=""><td></td><td></td><td></td></condition<>			
		-		th no voltage applied at a temperature of $105 \pm$	
				s period the capacitors shall be removed from bilized at room temperature for 4~8 hours. N	
	Shelf			imiting resistor($1k \pm 100\Omega$) with D.C. rated	-
4.8	life			the capacitors shall be discharged, and then, to	
	test	characteristi			

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		<criteria></criteria>	meet the following requirements.
		Leakage current	Value in 4.3 shall be satisfied
	Shelf	Capacitance Change	Within $\pm 20\%$ of initial value.
4.8	life	tanδ	Not more than 200% of the specified value.
	test	Appearance	There shall be no leakage of electrolyte.
			stored more than 1 year, the leakage current may
		-	e through about 1 k Ω resistor, if necessary.
		<pre><condition></condition></pre>	
			e capacitor connected with a (100 \pm 50)/C _R (k Ω) resistor
			tted to 1000 cycles, each consisting of charge of 30 ± 5 s
		followed discharge of 5 min	
		The test temperature shall b	
		C _R :Nominal Capacitance (JF)
	Surge	<criteria></criteria>	
4.9	test	Leakage current	Not more than the specified value.
		Capacitance Change	Within $\pm 15\%$ of initial value.
		tanδ	Not more than the specified value.
		Appearance	There shall be no leakage of electrolyte.
		Attention:	
		over voltage as often applied	ge at abnormal situation only. It is not applicable to such
		over voltage as often applied	
10	Vibration test	perpendicular directions. Vibration frequency ra Peak to peak amplitude Sweep rate Mounting method: The capacitor with diameter g in place with a bracket. 4mm or les	e : 1.5mm : 10Hz ~ 55Hz ~ 10Hz in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30°
		<criteria> After the test, the follow: Inner construction Appearance</criteria>	To be soldered ing items shall be tested: No intermittent contacts, open or short circuiting. No damage of tab terminals or electrodes. No mechanical damage in terminal. No leakage of electrolyte or swelling of the case.

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		<condition> The capacitor shall be tes</condition>	ted under the following	conditions:	
		Soldering temperature	: 245±3°C		
		Dipping depth	: 2mm		
4.11	Solderability	Dipping speed	: 25±2.5mm	/s	
4.11	test	Dipping time	: 3±0.5s		
		<criteria></criteria>			
		Coating quality	A minimum	n of 95% of the surface be	eing
		Coaring quanty	immersed		
		<condition></condition>			
			citor shall be immersed i	nto colder both of	
					C (1
			onds or 400 ± 10 Cfor3	$^{+1}_{-0}$ seconds to 1.5~2.0mm	n from the
		body of capacitor.			
	Resistance to			hal temperature and norm	nal
4.12	solder heat	humidity for 1~2 hour <criteria></criteria>	s before measurement.		
	test		Not more than the	aposified value	
		Leakage current Capacitance Change	Not more than the Within $\pm 10\%$ of		
		tanδ	Not more than the		
		Appearance		eakage of electrolyte.	
		Tippominio			
		<condition></condition>			
		Temperature Cycle:Accor			all be
		placed in an oven, the con			
		Te	emperature	Time	
		(1)+20°C		≤ 3 Minutes	
	Change of	(2)Rated low temper	ature (-40°C) (-25°C)	30 ± 2 Minutes	
4.13	temperature	(3)Rated high temper	cature (+105 $^{\circ}$ C)	30 ± 2 Minutes	
	test	(1) to (3)=1 cycle, to		I	
		<criteria></criteria>			
		The characteristic shall m	eet the following requir	ement	
		Leakage current	Not more than the s		
		tanδ	Not more than the s	pecified value.	
		Appearance		akage of electrolyte.	
		<condition></condition>			
		Humidity Test:			
		•	-4No.4.12methods, cap	acitor shall	
		-	hours in an atmosphere		
		40 ± 2 °C, the characteri	stic change shall meet th	ne following requirement	
4.14	Damp heat	<criteria></criteria>			
4.14	test	Leakage current	Not more than the spe	cified value.	
		Capacitance Change	Within $\pm 20\%$ of init		
		tanδ	Not more than 120% of		
		Appearance	There shall be no leak	-	

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4.16 (ripple current) 6.8~180 0.40 (produc	oducts with	vent product	s at diamete
4.15Vent testThe capacitor is connected with its polari current selected from Table 2 is applied.4.15Vent test <table 3=""> Diameter (mm) DC Current (A) 22.4 or less 1<2.4 or less 1</br></table>				s at thanket
4.15test $< Table 3 >$ $\boxed{\text{Diameter (mm)} DC \ Current (A)}{22.4 \text{ or less} 1}$ $< Criteria >$ The vent shall operate with no dangerous compleces of the capacitor and/or case. $< Condition >$ The maximum permissible ripple current at 120Hz and can be applied at maximum Table-1The combined value of D.C voltage and the rated voltage and shall not reverse voltageFrequency Multipliers: $< Coefficient \ (Hz) \ 120 \ Cap. (\mu F) \ 1~5.6 \ 0.20 \ (model) \ 0.40 \ (model) \ 0.40$		reversed to a	a DC power s	ource. Then
4.16 Maximum permissible (ripple current) 4.16 Maximum permissible (ripple current) 4.16 (ripple current)				
4.16 Maximum permissible (ripple current) Maximum permissible (ripple current) 4.16 (ripple current) 4.16 (ripple current) The maximum permissible ripple current (ripple current) The maximum permissible ripple current) The maximum permissible ripple current (ripple current) The maximum permissible (ripple current) The maximum permissible (ripple current) The combined value of D.C voltage and the rated voltage and shall not reverse voltage Frequency Multipliers: Coefficient (Hz) 120 Cap. (µ F) 120 Cap. (µ F) 120 Cap. (a F) 120 Cap. (b F) 120 Cap. (a F) 120 Cap. (b F) 12	ndition	litions such a	as flames or	dispersion o
4.16 Maximum permissible (ripple current) $6.8 \sim 180$ 0.40 0.40	m operation the pea	operating tem e peak A.C v	perature	
4.16 Maximum permissible (ripple current) $6.8 \sim 180$ 0.40 0				-
4.16 permissible (ripple current) 1~5.6 0.20 0 6.8~180 0.40 0 0 0 0	1k	k 10k	100k	
current) 6.8~180 0.40 (0.40	40 0.80	1.00	
220~ 0.50 (0.75	75 0.90	1.00	
	0.85	85 0.94	1.00	

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5. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances
	Cadmium and cadmium compounds
Heavy metals	Lead and lead compounds
Treavy metals	Mercury and mercury compounds
	Hexavalent chromium compounds
	Polychlorinated biphenyls (PCB)
Chloinated	Polychlorinated naphthalenes (PCN)
organic	Polychlorinated terphenyls (PCT)
compounds	Short-chain chlorinated paraffins(SCCP)
	Other chlorinated organic compounds
D	Polybrominated biphenyls (PBB)
Brominated organic	Polybrominated diphenylethers(PBDE) (including
	decabromodiphenyl ether[DecaBDE])
compounds	Other brominated organic compounds
Tributyltin comp	oounds(TBT)
Triphenyltin con	npounds(TPT)
Asbestos	
Specific azo com	pounds
Formaldehyde	
Beryllium oxide	
Beryllium copp	er
Specific phthalat	es (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)
Perfluorooctane	sulfonates (PFOS)
Specific Benzotr	iazole

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SAMXON

Attachment: Application Guidelines

1.Circuit Design

- 1.1 Operating Temperature and Frequency Electrolytic capacitor electrical parameters are normally specified at 20°C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.
- (1) Effects of operating temperature on electrical parameters

 At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while tand increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

(2) Capacitors Connected in Series

Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.

- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board.

When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

(4) Clearance for Case Mounted Pressure Relief vents

Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.

φ6.3~φ16mm:2mm minimum, φ18~φ35mm:3mm minimum, φ40mm or greater:5mm minimum.

(5) Clearance for Seal Mounted Pressure Relief Vents

A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.

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RH SERIES
 (6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite. (7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short. (8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.
 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows. Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.
1.7 The Product endurance should take the sample as the standard.
1.8 If conduct the load or shelf life test, must be collect date code within 6 months products of sampling.
 1.9 Capacitor Sleeve The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.
CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.
 2.Capacitor Handling Techniques 2.1 Considerations Before Using Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment. (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about 1kΩ. (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately 1kΩ. (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors. (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
 2.2 Capacitor Insertion (1) Verify the correct capacitance and rated voltage of the capacitor. (2) Verify the correct polarity of the capacitor before inserting. (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals. (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor. For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.
 2.3 Manual Soldering (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 °C for 3 seconds or less. (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal. (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads. (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.
2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.
- 2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve. For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

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2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.
- 2.7 Circuit Board Cleaning

Acetone

- (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried. The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- (2) Avoid using the following solvent groups unless specifically allowed for in the specification;

Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.

- Alkali solvents : could attack and dissolve the aluminum case.
- Petroleum based solvents: deterioration of the rubber seal could result.
- Xylene : deterioration of the rubber seal could result.
 - : removal of the ink markings on the vinyl sleeve could result.
- (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor. Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers. After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures.

If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water.

If electrolyte or gas is ingested by month, gargle with water.

If electrolyte contacts the skin, wash with soap and water.

5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail. After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000Ω , current limiting resistor for a time period of 30 minutes. If the expired date of products date code is over eighteen months, the products should be return to confirmation.

5.1 Environmental Conditions

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The capacitor shall be not use in the following condition:

(1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.

(2) Direct contact with water, salt water, or oil.

(3) High humidity conditions where water could condense on the capacitor.

(4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.

(5) Exposure to ozone, radiation, or ultraviolet rays.

(6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the

polyvinyl chloride sleeve, etc.

Dispose of as solid waste.

NOTE: Local laws may have specific disposal requirements, which must be followed.

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